

## P-Channel 30 V (D-S) MOSFET

### PRODUCT SUMMARY

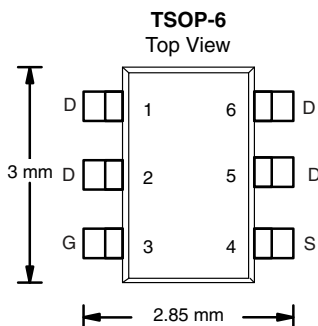
| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ ) Max. | $I_D$ (A) <sup>d,e</sup> | $Q_g$ (Typ.) |
|--------------|--------------------------------|--------------------------|--------------|
| -30          | 0.0192 at $V_{GS} = -10$ V     | -8                       | 21 nC        |
|              | 0.0232 at $V_{GS} = -6$ V      | -8                       |              |
|              | 0.0270 at $V_{GS} = -4.5$ V    | -8                       |              |

### FEATURES

- TrenchFET® Power MOSFET
- 100 %  $R_g$  and UIS Tested
- Material categorization:  
For definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



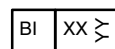
**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available



### APPLICATIONS

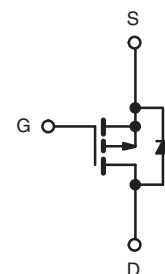
- Load Switches
- Adaptor Switch
- DC/DC Converter
- For Mobile Computing/Consumer

Marking Code



Lot Traceability  
and Date Code

Part # Code



P-Channel MOSFET

### Ordering Information:

Si3421DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)

| Parameter                                        | Symbol         | Limit                | Unit |
|--------------------------------------------------|----------------|----------------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | -30                  | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$             |      |
| Continuous Drain Current ( $T_J = 150$ °C)       | $I_D$          | $T_C = 25$ °C        | A    |
|                                                  |                | $T_C = 70$ °C        |      |
|                                                  |                | $T_A = 25$ °C        |      |
|                                                  |                | $T_A = 70$ °C        |      |
| Pulsed Drain Current ( $t = 100$ $\mu$ s)        | $I_{DM}$       | -50                  | A    |
| Continuous Source-Drain Diode Current            | $I_S$          | -3.5                 |      |
|                                                  |                | -1.7 <sup>a, b</sup> |      |
| Avalanche Current                                | $I_{AS}$       | -15                  | mJ   |
| Single-Pulse Avalanche Energy                    | $E_{AS}$       | 11.25                |      |
| Maximum Power Dissipation                        | $P_D$          | $T_C = 25$ °C        | W    |
|                                                  |                | $T_C = 70$ °C        |      |
|                                                  |                | $T_A = 25$ °C        |      |
|                                                  |                | $T_A = 70$ °C        |      |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | -55 to 150           | °C   |

### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol     | Typical | Maximum | Unit |
|---------------------------------------------|------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>a, c</sup> | $R_{thJA}$ | 40      | 62.5    | °C/W |
| Maximum Junction-to-Foot                    | $R_{thJF}$ | 25      | 30      |      |

Notes:

- Surface mounted on 1" x 1" FR4 board.
- $t = 10$  s.
- Maximum under steady state conditions is 110 °C/W.
- Based on  $T_C = 25$  °C.
- Package limited.

| SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted) |                                      |                                                                                                                              |      |        |        |       |
|-----------------------------------------------------------------|--------------------------------------|------------------------------------------------------------------------------------------------------------------------------|------|--------|--------|-------|
| Parameter                                                       | Symbol                               | Test Conditions                                                                                                              | Min. | Typ.   | Max.   | Unit  |
| Static                                                          |                                      |                                                                                                                              |      |        |        |       |
| Drain-Source Breakdown Voltage                                  | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA                                                                              | -30  |        |        | V     |
| V <sub>DS</sub> Temperature Coefficient                         | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = -250 μA                                                                                                     |      | -18    |        | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient                     | ΔV <sub>GS(th)</sub> /T <sub>J</sub> |                                                                                                                              |      | 4.6    |        |       |
| Gate-Source Threshold Voltage                                   | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA                                                                 | -1   |        | -3     | V     |
| Gate-Source Leakage                                             | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                              |      |        | ± 100  | nA    |
| Zero Gate Voltage Drain Current                                 | I <sub>DSS</sub>                     | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V                                                                               |      |        | -1     | μA    |
|                                                                 |                                      | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                                                       |      |        | -5     |       |
| On-State Drain Current <sup>a</sup>                             | I <sub>D(on)</sub>                   | V <sub>DS</sub> ≥ -10 V, V <sub>GS</sub> = -10 V                                                                             | -30  |        |        | A     |
| Drain-Source On-State Resistance <sup>a</sup>                   | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = -10 V, I <sub>D</sub> = -7 A                                                                               |      | 0.0160 | 0.0192 | Ω     |
|                                                                 |                                      | V <sub>GS</sub> = -6 V, I <sub>D</sub> = -5 A                                                                                |      | 0.0193 | 0.0232 |       |
|                                                                 |                                      | V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -3 A                                                                              |      | 0.0225 | 0.0270 |       |
| Forward Transconductance <sup>a</sup>                           | g <sub>fs</sub>                      | V <sub>DS</sub> = -10 V, I <sub>D</sub> = -7 A                                                                               |      | 30     |        | S     |
| Dynamic <sup>b</sup>                                            |                                      |                                                                                                                              |      |        |        |       |
| Input Capacitance                                               | C <sub>iss</sub>                     | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                                                    |      | 2580   |        | pF    |
| Output Capacitance                                              | C <sub>oss</sub>                     |                                                                                                                              |      | 256    |        |       |
| Reverse Transfer Capacitance                                    | C <sub>rss</sub>                     |                                                                                                                              |      | 225    |        |       |
| Total Gate Charge                                               | Q <sub>g</sub>                       | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -8.3 A                                                    |      | 46     | 69     | nC    |
|                                                                 |                                      | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -8.3 A                                                   |      | 21     | 32     |       |
| Q <sub>gs</sub>                                                 |                                      |                                                                                                                              | 7    |        |        |       |
| Q <sub>gd</sub>                                                 |                                      |                                                                                                                              | 6.1  |        |        |       |
| Gate Resistance                                                 | R <sub>g</sub>                       | f = 1 MHz                                                                                                                    | 1.6  | 8      | 16     | Ω     |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = -15 V, R <sub>L</sub> = 2.24 Ω<br>I <sub>D</sub> ≡ -6.7 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω  |      | 7      | 14     | ns    |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                              |      | 9      | 18     |       |
| Turn-Off DelayTime                                              | t <sub>d(off)</sub>                  |                                                                                                                              |      | 55     | 83     |       |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                              |      | 13     | 20     |       |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = -15 V, R <sub>L</sub> = 2.24 Ω<br>I <sub>D</sub> ≡ -6.7 A, V <sub>GEN</sub> = -4.5 V, R <sub>g</sub> = 1 Ω |      | 58     | 87     |       |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                              |      | 40     | 60     |       |
| Turn-Off DelayTime                                              | t <sub>d(off)</sub>                  |                                                                                                                              |      | 36     | 54     |       |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                              |      | 17     | 26     |       |
| Drain-Source Body Diode Characteristics                         |                                      |                                                                                                                              |      |        |        |       |
| Continous Source-Drain Diode Current                            | I <sub>S</sub>                       | T <sub>C</sub> = 25 °C                                                                                                       |      |        | -3.5   | A     |
| Pulse Diode Forward Current (t = 100 μs)                        | I <sub>SM</sub>                      |                                                                                                                              |      |        | -50    |       |
| Body Diode Voltage                                              | V <sub>SD</sub>                      | I <sub>S</sub> = -6.7 A, V <sub>GS</sub> = 0 V                                                                               |      | -0.85  | -1.2   | V     |
| Body Diode Reverse Recovery Time                                | t <sub>rr</sub>                      | I <sub>F</sub> = -6.7 A, dI/dt = 100 A/μs,<br>T <sub>J</sub> = 25 °C                                                         |      | 21.5   | 33     | ns    |
| Body Diode Reverse Recovery Charge                              | Q <sub>rr</sub>                      |                                                                                                                              |      | 12     | 20     | nC    |
| Reverse Recovery Fall Time                                      | t <sub>a</sub>                       |                                                                                                                              |      | 10.5   |        | ns    |
| Reverse Recovery Rise Time                                      | t <sub>b</sub>                       |                                                                                                                              |      | 11     |        |       |

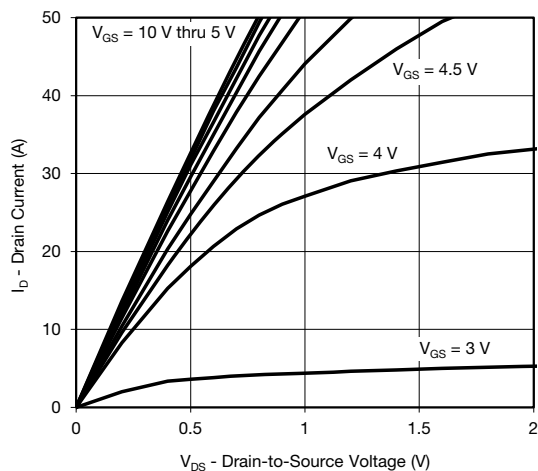
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

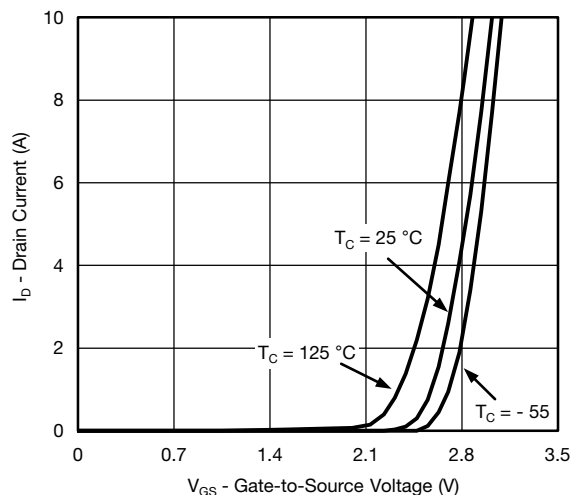
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

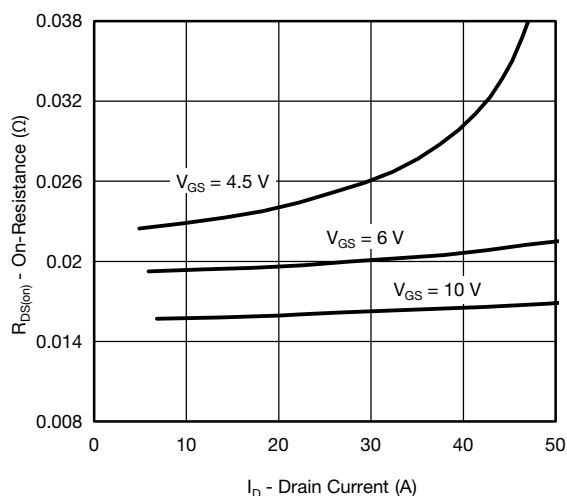
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



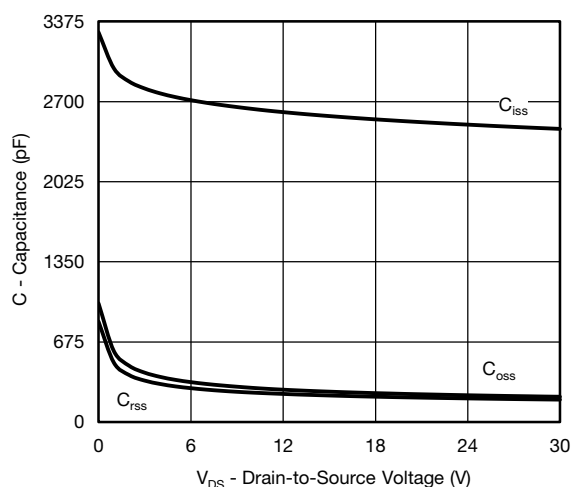
Output Characteristics



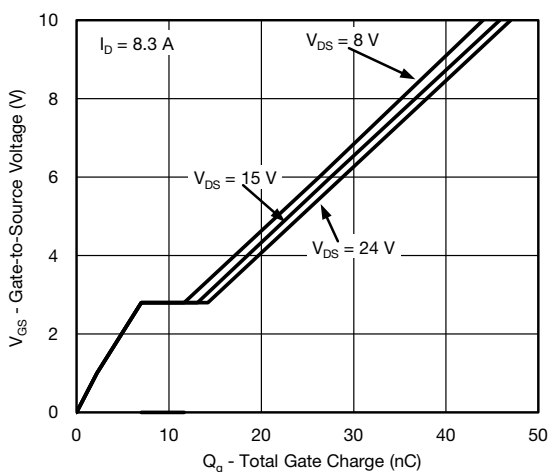
Transfer Characteristics



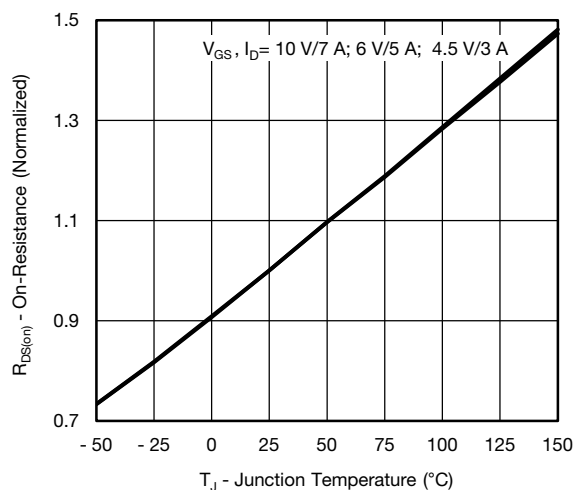
On-Resistance vs. Drain Current



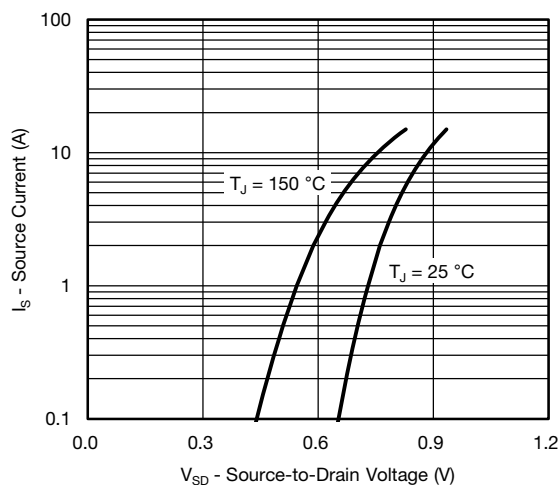
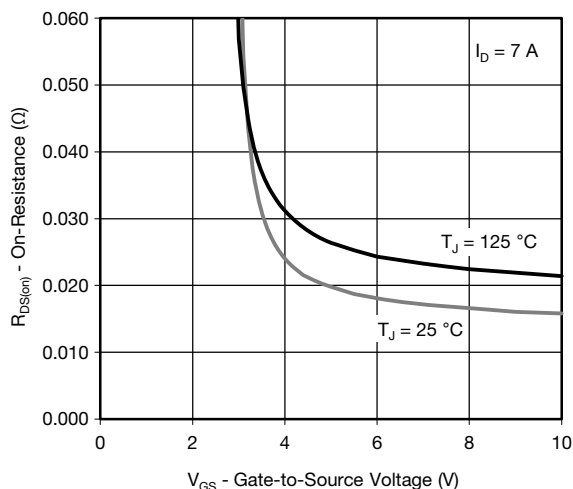
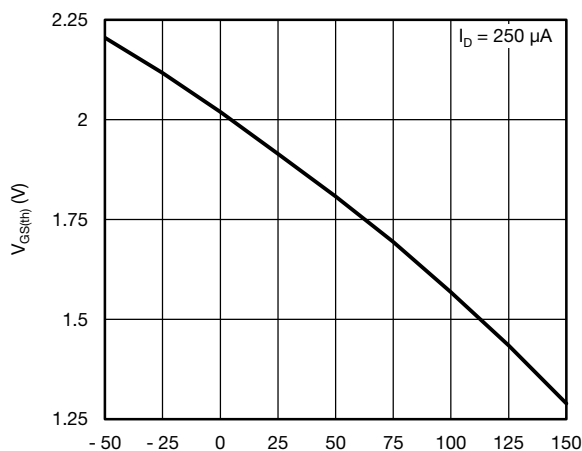
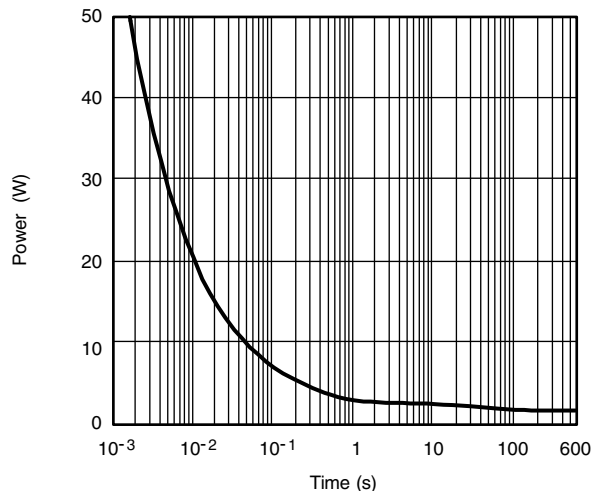
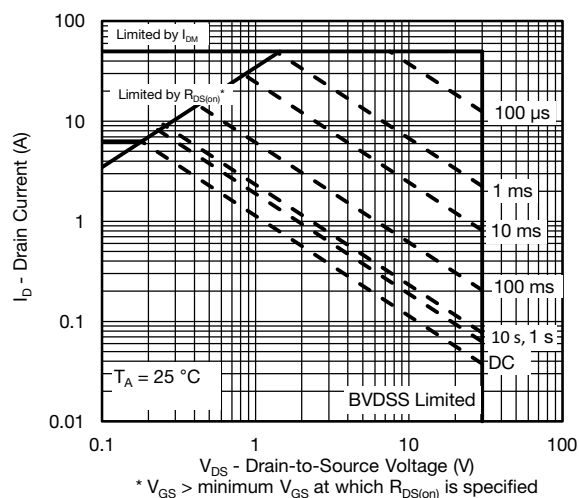
Capacitance



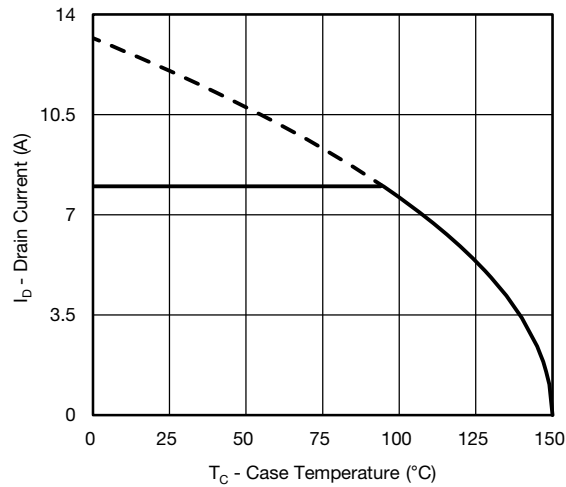
Gate Charge



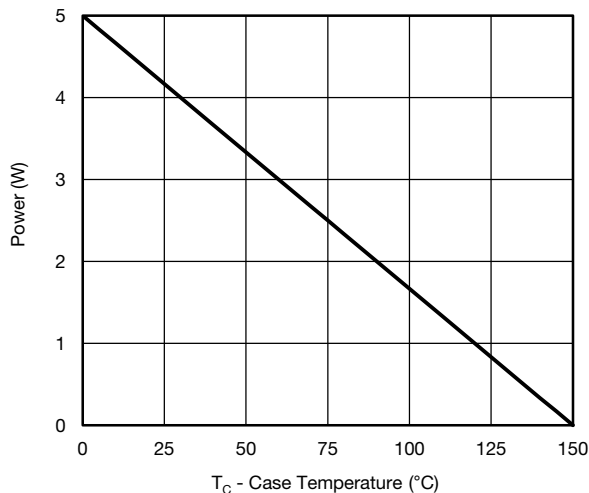
On-Resistance vs. Junction Temperature

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power, Junction-to-Ambient****Safe Operating Area**

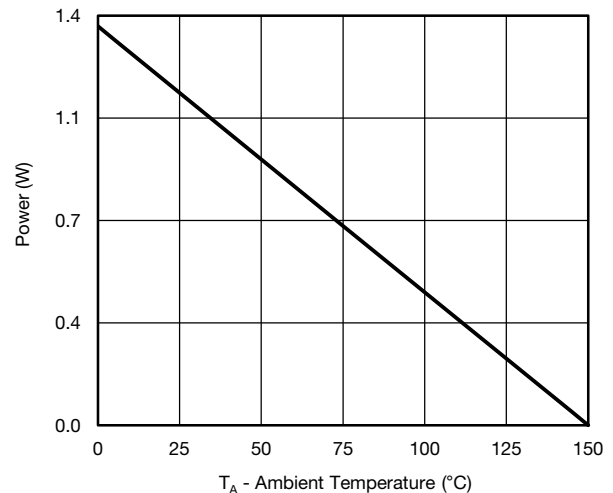
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating\*

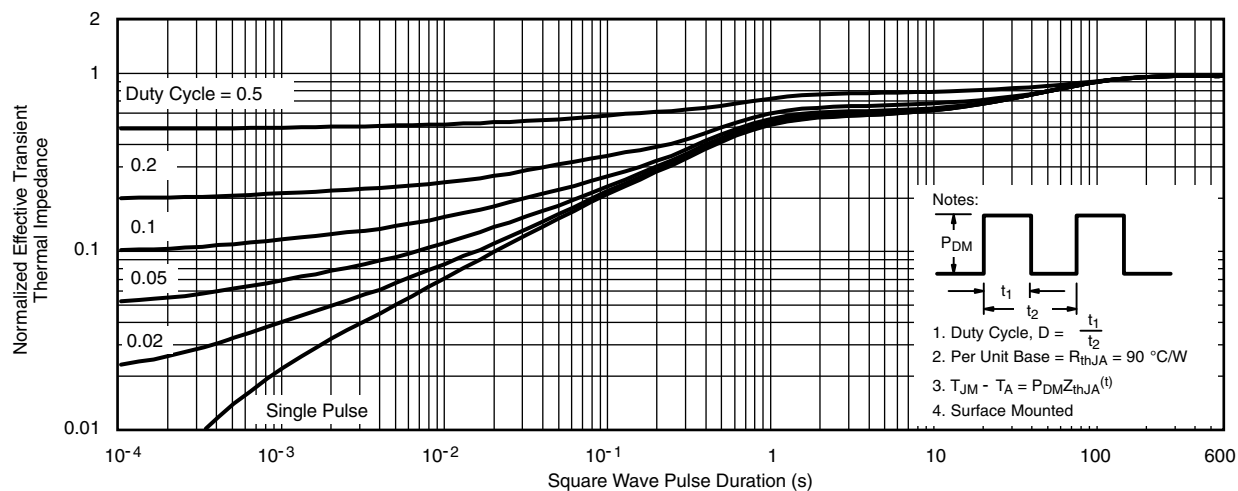
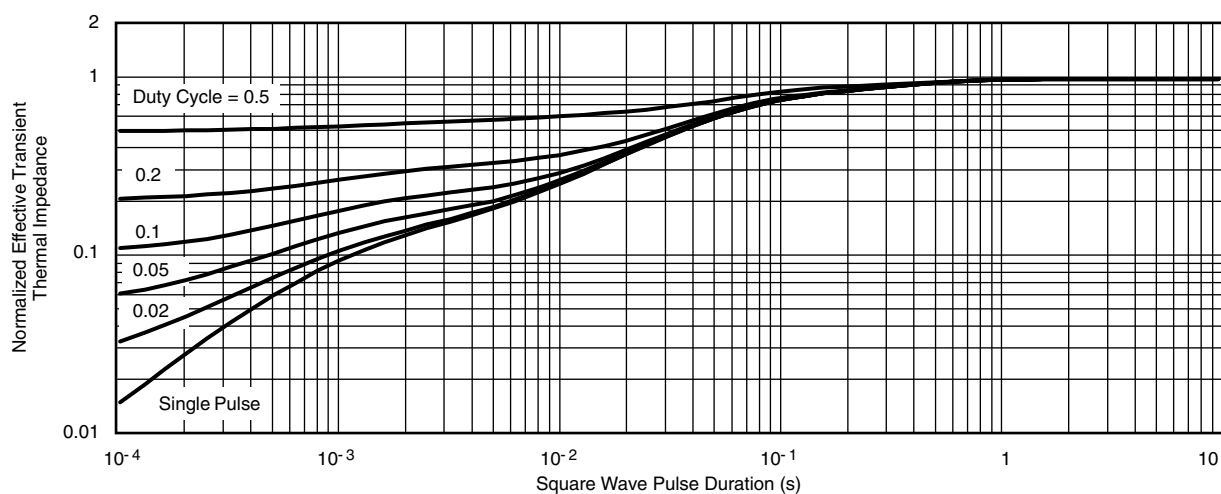


Power, Junction-to-Case



Power Derating, Junction-to-Ambient

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Foot**

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## TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C



5-LEAD TSOP

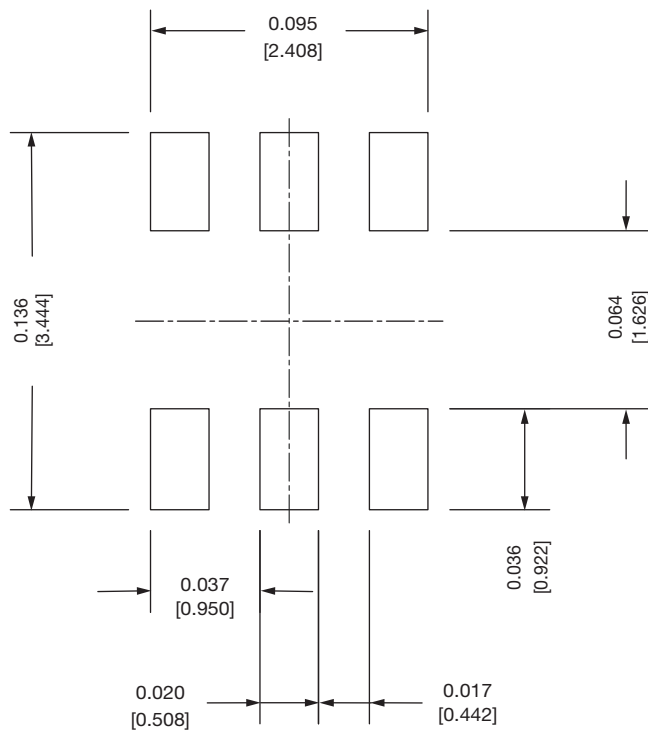
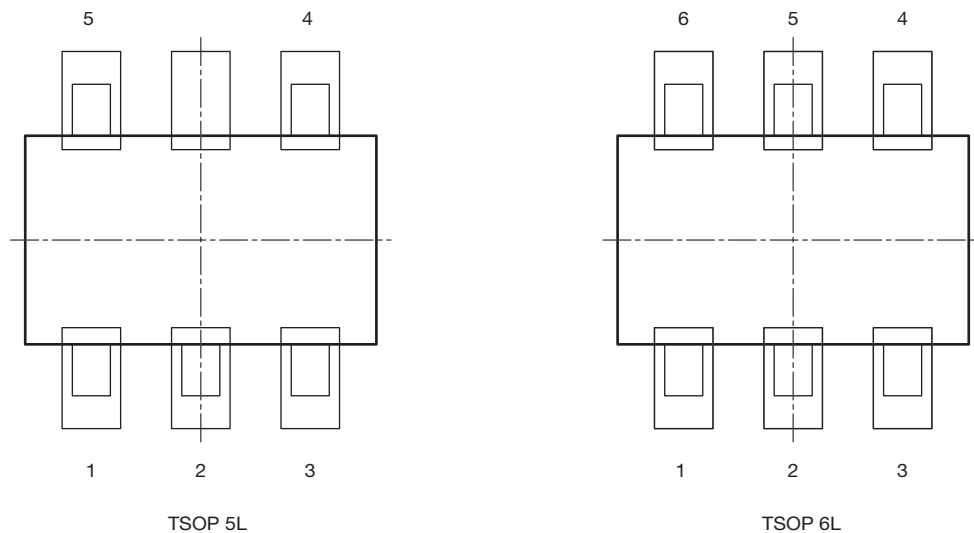


6-LEAD TSOP



|                                | MILLIMETERS |      |      | INCHES     |       |       |
|--------------------------------|-------------|------|------|------------|-------|-------|
| Dim                            | Min         | Nom  | Max  | Min        | Nom   | Max   |
| A                              | 0.91        | -    | 1.10 | 0.036      | -     | 0.043 |
| A <sub>1</sub>                 | 0.01        | -    | 0.10 | 0.0004     | -     | 0.004 |
| A <sub>2</sub>                 | 0.90        | -    | 1.00 | 0.035      | 0.038 | 0.039 |
| b                              | 0.30        | 0.32 | 0.45 | 0.012      | 0.013 | 0.018 |
| c                              | 0.10        | 0.15 | 0.20 | 0.004      | 0.006 | 0.008 |
| D                              | 2.95        | 3.05 | 3.10 | 0.116      | 0.120 | 0.122 |
| E                              | 2.70        | 2.85 | 2.98 | 0.106      | 0.112 | 0.117 |
| E <sub>1</sub>                 | 1.55        | 1.65 | 1.70 | 0.061      | 0.065 | 0.067 |
| e                              | 0.95 BSC    |      |      | 0.0374 BSC |       |       |
| e <sub>1</sub>                 | 1.80        | 1.90 | 2.00 | 0.071      | 0.075 | 0.079 |
| L                              | 0.32        | -    | 0.50 | 0.012      | -     | 0.020 |
| L <sub>1</sub>                 | 0.60 Ref    |      |      | 0.024 Ref  |       |       |
| L <sub>2</sub>                 | 0.25 BSC    |      |      | 0.010 BSC  |       |       |
| R                              | 0.10        | -    | -    | 0.004      | -     | -     |
| θ                              | 0°          | 4°   | 8°   | 0°         | 4°    | 8°    |
| θ <sub>1</sub>                 | 7° Nom      |      |      | 7° Nom     |       |       |
| ECN: C-06593-Rev. I, 18-Dec-06 |             |      |      |            |       |       |
| DWG: 5540                      |             |      |      |            |       |       |

## Recommended Land Pattern For TSOP-5L / TSOP-6L


**Note**

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022  
DWG: 3010



## Disclaimer

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